MC74HC11A

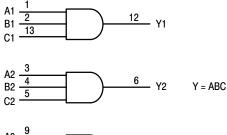
Triple 3-Input AND Gate

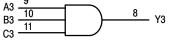
High-Performance Silicon-Gate CMOS

The MC74HC11A is identical in pinout to the LS11. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs.

Features

- Output Drive Capability: 10 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2 V to 6 V
- Low Input Current: 1 μA
- High Noise Immunity Characteristic of CMOS Devices
- NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free and are RoHS Compliant





PIN 14 = V_{CC} PIN 7 = GND

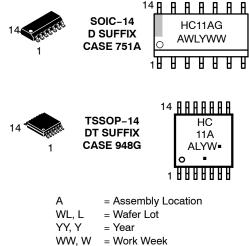
Figure 1. Logic Diagram



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MARKING DIAGRAMS



G or	•	= Pb-Free Package	

(Note: Microdot may be in either location)

PIN ASSIGNMENT							
1•	14	l v _{cc}					
2	13] C1					
3	12] Y1					
4	11] C3					
5	10] B3					
6	9] A3					
7	8] Y3					
	1● 2 3 4 5 6	1 ● 14 2 13 3 12 4 11 5 10 6 9					

FUNCTION TABLE

	Output		
Α	В	С	Y
L	Х	Х	L
Х	L	Х	L
Х	Х	L	L
Н	н	Н	н

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

1

MAXIMUM RATINGS*

Symbol	Parameter	Value	Unit	
V _{CC}	DC Supply Voltage (Referenced	to GND)	-0.5 to +7.0	V
V _{in}	DC Input Voltage (Referenced to	o GND)	–0.5 to V _{CC} +0.5	V
V _{out}	DC Output Voltage (Referenced	–0.5 to V _{CC} +0.5	V	
l _{in}	DC Input Current, per Pin	±20	mA	
l _{out}	DC Output Current, per Pin		±25	mA
I _{CC}	DC Supply Current, V_{CC} and GN	ND Pins	±50	mA
P _D	Power Dissipation in Still Air	SOIC Package TSSOP Package	500 450	mW
T _{stg}	Storage Temperature		-65 to +150	°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high–impedance circuit. For proper operation, V_{in} and V_{out} should be constrained to the range GND $\leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter			Max	Unit
V _{CC}	DC Supply Voltage (Referenced to GND)	DC Supply Voltage (Referenced to GND)			V
V _{in} , V _{out}	DC Input Voltage, Output Voltage (Referenced to GND)			V _{CC}	V
T _A	Operating Temperature, All Package Types			+125	°C
t _r , t _f	(Figure 2) V _{CC} = V _{CC} =	= 2.0 V = 3.0 V = 4.5 V = 6.0 V	0 0 0 0	1000 600 500 400	ns

MC74HC11A

				Gu	Guaranteed Limit			
Symbol	Parameter	Test Conditions	V _{CC} V	- 55 to 25°C	≤ 85 °C	≤ 125°C	Unit	
V _{IH}	Minimum High-Level Input Voltage	$\begin{array}{l} V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V} \\ \left I_{out}\right \leq 20 \ \mu\text{A} \end{array}$	2.0 3.0 4.5 6.0	1.5 2.1 3.15 4.2	1.5 2.1 3.15 4.2	1.5 2.1 3.15 4.2	V	
V _{IL}	Maximum Low-Level Input Voltage	$\begin{array}{l} V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V} \\ \left I_{out}\right \leq 20 \ \mu\text{A} \end{array}$	2.0 3.0 4.5 6.0	0.5 0.9 1.35 1.8	0.5 0.9 1.35 1.8	0.5 0.9 1.35 1.8	V	
V _{OH}	Minimum High-Level Output Voltage		2.0 4.5 6.0	1.9 4.4 5.9	1.9 4.4 5.9	1.9 4.4 5.9	V	
		$ \begin{aligned} V_{\text{in}} = V_{\text{IH}} \text{ or } V_{\text{IL}} & _{\text{out}} \leq 2.4 \text{ mA} \\ _{\text{out}} \leq 4.0 \text{ mA} \\ _{\text{out}} \leq 5.2 \text{ mA} \end{aligned} $	3.0 4.5 6.0	2.48 3.98 5.48	2.34 3.84 5.34	2.20 3.70 5.20		
V _{OL}	Maximum Low-Level Output Voltage	$V_{in} = V_{IH}$ $ I_{out} \le 20 \ \mu A$	2.0 4.5 6.0	0.1 0.1 0.1	0.1 0.1 0.1	0.1 0.1 0.1	V	
		$ \begin{array}{ll} V_{in} = V_{IH} \text{ or } V_{IL} & \left I_{out} \right \leq 2.4 \text{ mA} \\ \left I_{out} \right \leq 4.0 \text{ mA} \\ \left I_{out} \right \leq 5.2 \text{ mA} \end{array} $	3.0 4.5 6.0	0.26 0.26 0.26	0.33 0.33 0.33	0.40 0.40 0.40		
l _{in}	Maximum Input Leakage Current	V _{in} = V _{CC} or GND	6.0	± 0.1	± 1.0	± 1.0	μA	
I _{CC}	Maximum Quiescent Supply Current (per Package)	$V_{in} = V_{CC}$ or GND $I_{out} = 0 \ \mu A$	6.0	1	10	40	μA	

DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

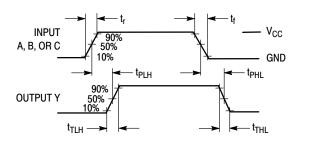
AC ELECTRICAL CHARACTERISTICS (C_L = 50 pF, Input t_{f} = t_{f} = 6 ns)

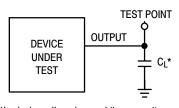
			Guaranteed Limit			
Symbol	Parameter	v _{cc} v	- 55 to 25°C	≤ 85°C	≤ 125°C	Unit
t _{PLH} , t _{PHL}	Maximum Propagation Delay, Input A, B, or C to Output Y (Figures 2 and 3)	2.0 3.0 4.5 6.0	95 45 19 16	120 60 24 20	145 75 29 25	ns
t _{TLH} , t _{THL}	Maximum Output Transition Time, Any Output (Figures 2 and 3)	2.0 3.0 4.5 6.0	75 30 15 13	95 40 19 16	110 55 22 19	ns
C _{in}	Maximum Input Capacitance	-	10	10	10	pF

		Typical @ 25°C, V _{CC} = 5.0 V	
C _{PD}	Power Dissipation Capacitance (Per Gate)*	27	pF

*Used to determine the no-load dynamic power consumption: $P_D = C_{PD} V_{CC} 2f + I_{CC} V_{CC}$.

MC74HC11A

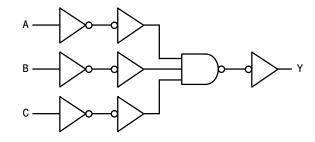


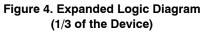


*Includes all probe and jig capacitance

Figure 3. Test Circuit

Figure 2. Switching Waveforms





ORDERING INFORMATION

Device	Package	Shipping [†]
MC74HC11ADG	SOIC-14 (Pb-Free)	55 Units / Rail
MC74HC11ADR2G	SOIC-14 (Pb-Free)	2500 / Tape & Reel
MC74HC11ADTG	TSSOP-14 (Pb-Free)	96 Units / Tube
MC74HC11ADTR2G	TSSOP-14 (Pb-Free)	2500 / Tape & Reel
NLV74HC11ADR2G*	SOIC-14 (Pb-Free)	2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*NLV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable

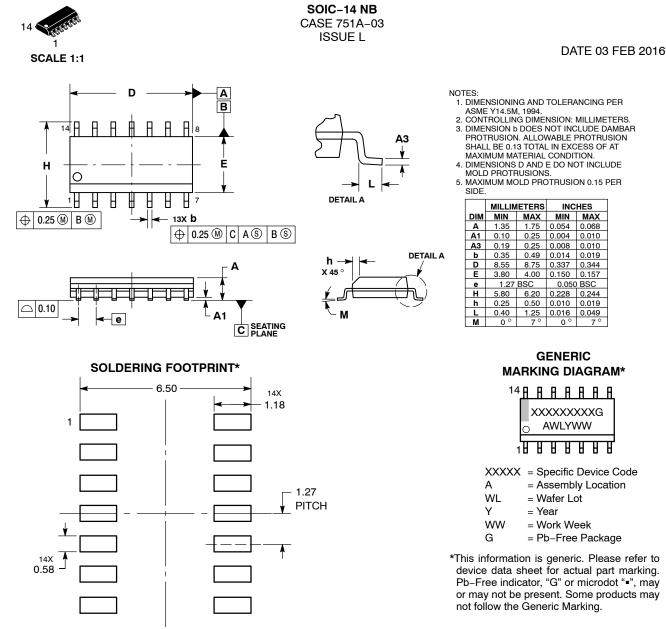
DUSEM

0.068

0.019

0.344

0.244



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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SOIC-14 CASE 751A-03 ISSUE L

DATE 03 FEB 2016

STYLE 1: PIN 1. COMMON CATHODE 2. ANODE/CATHODE 3. ANODE/CATHODE 4. NO CONNECTION 5. ANODE/CATHODE 6. NO CONNECTION 7. ANODE/CATHODE 8. ANODE/CATHODE 9. ANODE/CATHODE 10. NO CONNECTION 11. ANODE/CATHODE 12. ANODE/CATHODE 13. NO CONNECTION 14. COMMON ANODE	STYLE 2: CANCELLED	STYLE 3: PIN 1. NO CONNECTION 2. ANODE 3. ANODE 4. NO CONNECTION 5. ANODE 6. NO CONNECTION 7. ANODE 8. ANODE 9. ANODE 10. NO CONNECTION 11. ANODE 12. ANODE 13. NO CONNECTION 14. COMMON CATHODE	STYLE 4: PIN 1. NO CONNECTION 2. CATHODE 3. CATHODE 4. NO CONNECTION 5. CATHODE 6. NO CONNECTION 7. CATHODE 8. CATHODE 9. CATHODE 10. NO CONNECTION 11. CATHODE 12. CATHODE 13. NO CONNECTION 14. COMMON ANODE
STYLE 5:	STYLE 6:	STYLE 7:	STYLE 8:
PIN 1. COMMON CATHODE	PIN 1. CATHODE	PIN 1. ANODE/CATHODE	PIN 1. COMMON CATHODE
2. ANODE/CATHODE	2. CATHODE	2. COMMON ANODE	2. ANODE/CATHODE
3. ANODE/CATHODE	3. CATHODE	3. COMMON CATHODE	3. ANODE/CATHODE
4. ANODE/CATHODE	4. CATHODE	4. ANODE/CATHODE	4. NO CONNECTION
5. ANODE/CATHODE	5. CATHODE	5. ANODE/CATHODE	5. ANODE/CATHODE
6. NO CONNECTION	6. CATHODE	6. ANODE/CATHODE	6. ANODE/CATHODE
7. COMMON ANODE	7. CATHODE	7. ANODE/CATHODE	7. COMMON ANODE
8. COMMON CATHODE	8. ANODE	8. ANODE/CATHODE	8. COMMON ANODE
9. ANODE/CATHODE	9. ANODE	10. ANODE/CATHODE	9. ANODE/CATHODE
10. ANODE/CATHODE	10. ANODE	11. COMMON CATHODE	10. ANODE/CATHODE
11. ANODE/CATHODE	11. ANODE	12. COMMON CATHODE	11. NO CONNECTION
12. ANODE/CATHODE	12. ANODE	13. ANODE/CATHODE	12. ANODE/CATHODE
13. NO CONNECTION	13. ANODE	14. ANODE/CATHODE	13. ANODE/CATHODE
14. COMMON ANODE	14. ANODE	14. ANODE/CATHODE	14. COMMON CATHODE

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